

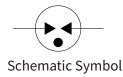
FEATURES

1	Surface	Mounting	Design !	5.0*5.0)*4.2mm
	Junace	mounting	Designi	5.0 5.0	/ 1.2111111

- High Current Handling Capability 5000A @ 8/20 μs
- Low Capacitance and Insertion Loss
- | Quick Response and Long Service Life
- Moisture sensitivity level:Level 1



5.0*5.0*4.2mm



APPLICATION INFORMATION

Communication equipment.	nt.
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- Repeaters, Modems
- | Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

Icon Solderability		
RoHS	Compliance with 2011/65/EU	
HF	Compliance with IEC61249-2-21:2003	
P	Mean lead free	
یک UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	480-720	V
Impulse Spark-over Voltage	At 1kV/µs	for 99 % of measured values \leq 1300	
inipulse spark-over voltage	At 1kV/µs	Typical values of distribution \leq 1200	V
Impulse Discharge Current 2)	8/20µs	5000	А
AC Discharge Current	50Hz, 1S, 10times	5	А
Insulation Resistance	DC=100V	≥1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 0.8	pF
Operating and Storage Temperature		-40-125	°C

1) In ionized mode

2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

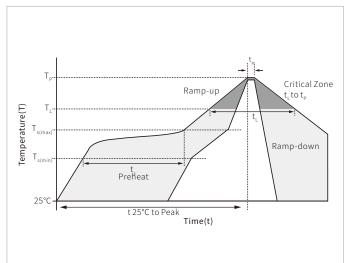
ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C ; Time:2H	
Low Temperature Storage Test	Temperature: -40°C; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude:0.15mm ; Time:45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering:10s, 1time	

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

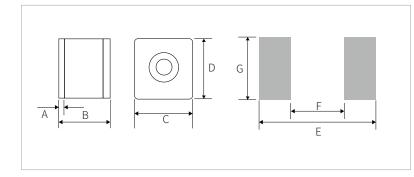
REFLOW PROFILE

	Reflow Condition	Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60 – 180 secs	
Average ra	mp up rate (Liquidus)Temp (T_L) to peak	3°C/second max	
	$T_{s(max)}$ to T_{L} - Ramp-up Rate		
Defleur	Temperature (T _L) (Liquidus)	217°C	
Reflow	Time(min to max)(t _s)	60 – 150 seconds	
Peak Terr	nperature (T _P)	260 °C	
Time with	iin 5°C of actual peak Temperature (tp)	20-40 seconds	
Ramp-do	own Rate	6°C/second max	
Time 25°	C to peak Temperature (T _P)	8 minutes max.	
Do not exceed		260°C	



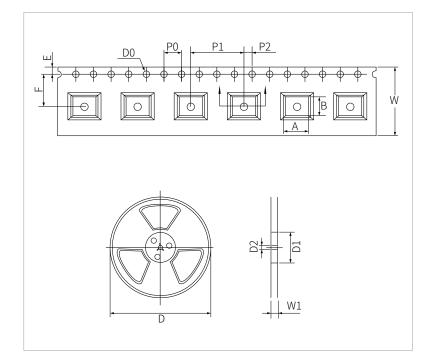


DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm	
А	0.5±0.1	
В	4.2±0.3	
С	5.0±0.2	
D 5.0±0.2		
E	4.7	
F	2.5	
G 5.5		

PACKAGE REEL INFORMATION



Ref.	mm	inch
А	5.5±0.1	0.217±0.004
В	4.7±0.2	0.185±0.008
D0	Φ1.5±0.1	Ф0.059±0.004
PO	4.0±0.1	0.157±0.004
P1	12.0±0.1	0.472±0.004
P2	2.0±0.1	0.079±0.004
E	1.75±0.1	0.069±0.004
F	7.5±0.1	0.295±0.004
W	16.0±0.3	0.630±0.012
D	Ф 330.0	Φ13.0
D1	Φ 50Min	Ф 1.97Min
D2	Φ13±0.15	0.512±0.006
W1	16.8±2.0	0.661±0.079

ORDERING INFORMATION

Part Number	Size	QTY/Reel	Reel Size
SG5042B600	5.0*5.0*4.2mm	1000	13"



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